

Electronic Patent Application Fee Transmittal

Application Number:	10812830			
Filing Date:	29-Mar-2004			
Title of Invention:	DEVICE AND METHOD FOR SOLDERING CONTACTS ON SEMICONDUCTOR CHIPS			
First Named Inventor/Applicant Name:	Robert Bergmann			
Filer:	Laura C. Brutman/Brenda Bridges			
Attorney Docket Number:	E0196.0006			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Printed copy of patent - no color	8001	1	3	3
Total in USD (\$)				1743